

High Efficiency, Low Noise, Ultra-Low Distortion, Constant Large Volume, Upgrade 7th-Generation Class K Audio Amplifier

FEATURES

- ◆ Low noise: 53µV
- Power Amplifier's Overall Efficiency: 80%
- Within Lithium Battery Voltage Range, **Outputs Constant Large Volume**
- Selectable Speaker-Guard Power Level: 0.6W, 0.8W, 1.0W, 1.2W
- No-Crack-Noise (NCN) Technology
- Super TDD-Noise Suppression
- Excellent Pop-Click Suppression
- One-Wire Pulse Control
- High PSRR: -68dB (217Hz)
- ESD Protection: ±6kV (HBM)
- Small Package
 - ◆ 1.60mm×1.60mm, 0.4mm Pitch FC-16

APPLICATIONS

Smart Phones

DESCRIPTION

AW8737A is specifically designed to enhance overall sound quality. It is an upgrading 7th-generation class K audio amplifier with high efficiency, low noise, ultra-low distortion and capability of outputting constant large volume.

With integrated AWINIC proprietary NCN output AGC audio algorithm, AW8737A can eliminate noise in playback and improve sound quality and effect. Using a novel K-Chargepump technology, its integrated charge pump efficiency can reach 93%, and power amplifier's overall efficiency can reach 80%. With high efficiency, AW8737A can greatly prolong smart phone usage time.

AW8737A noise floor is as low as to 53µV, with 97dB high signal-to-noise-ratio (SNR). The ultra-low 0.008% brings high-quality enjoyment.

AW8737A has a setting of 4-step selectable speakerguard output power level from 0.6W to 1.2W, suitable for different rated power speakers. Within lithium battery voltage range, it keeps output power constant, preventing voice from degrading.

The AW8737A uses Awinic proprietary TDD-Noise suppression technology and EMI suppression technology, effectively restrain TDD-Noise and EMI interference.

AW8737A has built-in over-current protection, overtemperature protection and short-circuit protection. AW8737A is available in a 1.60mm×1.60mm, 0.4mm pitch FC-16 package.

APPLICATION DIAGRAM

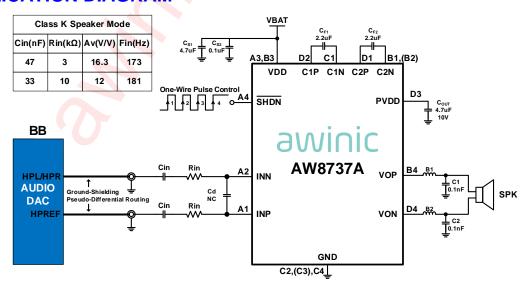


Figure 1 AW8737A Application Diagram

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PIN DIAGRAM AND DEVICE MARKING

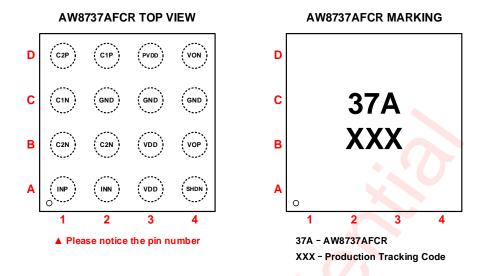


Figure 2 AW8737A Pin Diagram Top View and Device Marking

PIN DESCRIPTION

	AW8737AFCR						
Number	Symbol	Description					
A1	INP	Positive audio input					
A2	INN	Negative audio input					
A3, B3	VDD	Power supply					
A4	SHDN	Chip power down pin, active low: one wire pulse control					
B1, B2	C2N	Negative terminal of the charge pump flying capacitor C _{F2}					
B4	VOP	Positive audio output					
C1	C1N	Negative terminal of the charge pump flying capacitor C _{F1}					
C2, C3, C4	GND	Ground					
D1	C2P	Positive terminal of the charge pump flying capacitor C _{F2}					
D2	C1P	Positive terminal of the charge pump flying capacitor C _{F1}					
D3	PVDD	Charge pump output					
D4	VON	Negative audio output					



AWINIC CLASS K FAMILY

ITEM	TEST CONDITION	AW8736	AW8737	AW8737A	AW8738
PVDD (V)	VDD=4.2V	5.8	6.05	6.05	6.05
Ouput Noise (µV)	VDD=4.2V, f=20Hz to 20kHz Input ac grounded, 8V/V, A- weighting	125	52	53	40
Efficiency (%)	VDD=3.6V, Po=1.0W, R _L =8Ω+33μH	75	80	80	83

FUNCTIONAL DIAGRAM

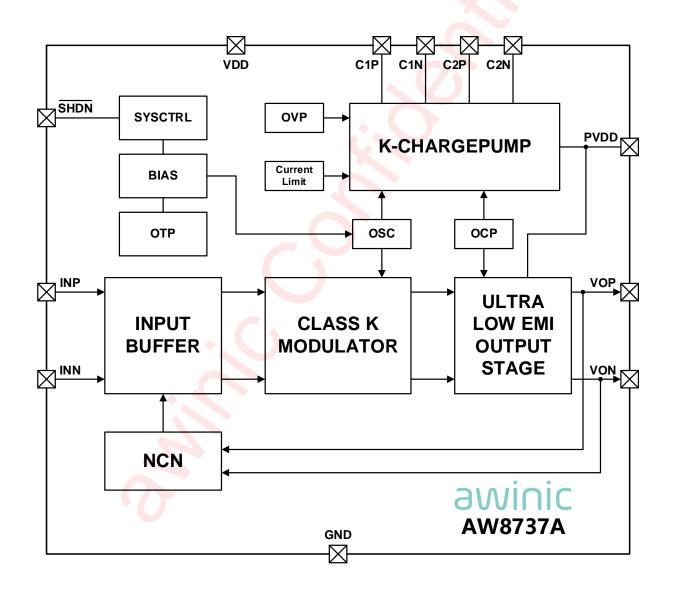


Figure 3 AW8737A Functional Diagram



APPLICATION DIAGRAM

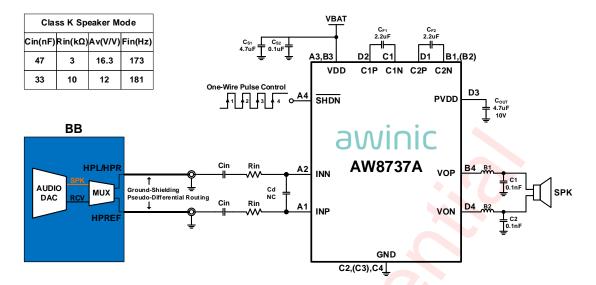


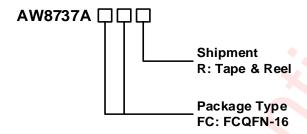
Figure 4 AW8737A Speaker Mode Application Diagram(Note 1)

Note1: When single-ended input, audio signal line from audio DAC (HPL or HPR) can arbitrarily connected to either of INN or INP input terminal. The other terminal must be connected to reference ground (HPREF) through input capacitor and resistor.



ORDERING INFORMATION

Product Type	Operation Temperature Range	Package	Device Marking	Moisture Sensitivity Level (MSL)	Environmental Information	Delivery Form
AW8737AFCR	-40°C to 85°C	FCQFN-16	37A	MSL1	ROHS+HF	Tape & Reel 3000 pcs





ABSOLUTE MAXIMUM RATINGS(NOTE2)

Parameter	Range				
Power Supply VDD Voltage	-0.3V to 6V				
Charge Pump Output PVDD Voltage	-0.3V to 7V				
VOP, VON, C1P, C2P	-0.3V to PVDD+0.3V				
C1N, C2N	-0.3V to VDD+0.3V				
Input Pin INP, INN Voltage	-0.3V to VDD+0.3V				
Operating Free-Air Temperature T _A	-40°C to 85°C				
Maximum Junction Temperature T _{JMAX}	165°C				
Storage Temperature T _{STG}	-40°C to 150°C				
Lead Temperature (Soldering 10 Seconds)	260°C				
ESD Rating					
Human Body Model (HBM) (Note 3)	±6kV				
Charged Device Model (CDM) (Note 4)	±2kV				
Latch-up					
Test Condition: JEDEC STANDARD NO.78D SEPTEMBER 2010	+IT: 450mA				
1650 CONDITION. JEDEC STANDAND NO. 70D SEPTEMBER 2010	-IT: -450mA				

Note 2: Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

Note 3: The human body model is a 100pF capacitor discharged through a 1.5k Ω resistor into each pin. Test method: MIL-STD-883J Method 3015.9.

Note 4: Test Method: ESDA/JEDEC JS-002-2014.



MODE DESCRIPTIONS (T_A=25°C, VDD=4.2V)

Under Speaker Mode (Mode 1 to Mode 4), audio signal is inserted through INP & INN pins. The AW8737A external input capacitor is Cin and the external input resistor is Rin.

1) Under Speaker Mode, the internal input resister is $16.6k\Omega$. The gain of AW8737A (Av) can be calculated by 319.5k/(Rin+16.6k) (Rin unit: Ω). Recommended operating external setting is: Cin=47nF, Rin=3k Ω , Av=16.3V/V or Rin=10k Ω , Av=12V/V.

The operating modes of AW8737A are listed below:

	Enable Signal	Gain	Gain (V/V)		NCN Power Level (W)		
MODE	(SHDN)	Rin=3kΩ	Rin=10kΩ	R _L =8Ω +33μΗ	R _L =6Ω +33μH	NCN Function	
1		16.3	12	1.2	1.6	V	
2		16.3	12	1.0	1.3	√	
3		16.3	12	0.8	1.0	√	
4		16.3	12	0.6	0.8	√	



ELECTRICAL CHARACTERISTICS

Test condition: T_A =25°C, VDD=3.6V, R_L =8 Ω +33 μ H, f=1kHz (unless otherwise noted)

	Parameter	Test Conditions	Min	Тур	Max	Unit
V_{DD}	Power supply voltage		3.0		5.5	V
V_{IH}	SHDN high input voltage		1.3		V_{DD}	V
V_{IL}	SHDN low input voltage		0		0.45	V
V _{os}	Output offset voltage	V _{IN} =0V, V _{DD} =3.0V to 5.5V	-30	0	30	mV
I _{SD}	Shutdown current	V _{DD} =3.6V, _{SHDN} =0V			2	μA
T_TG	Thermal AGC start temperature threshold	•		150		°C
T_{TGR}	Thermal AGC exit temperature threshold	X		130		°C
T_{SD}	Over temperature protection threshold			160		°C
T_{SDR}	Over temperature protection recovery threshold	. (7)		120		°C
T _{ON}	Start-up time			40		ms
K-Charg	epump	.*. 0				
PVDD	Output voltage	V _{DD} =3.0V to 4V		1.5× VDD		٧
		V _{DD} >4V		6.05		V
Vhys	OVP hysteresis voltage	V _{DD} >4V		50		mV
F_{CP}	Charge pump frequency	V _{DD} =3.0V to 5.5V	0.79	1.06	1.33	MHz
η_{CP}	Charge pump efficiency	V _{DD} =3.6V, I _{load} =200mA		93		%
T_{ST}	Soft-start time	No l <mark>o</mark> ad, C _{ουτ} = <mark>4.</mark> 7μF	1.0	1.2	1.4	ms
I _L	Current limit when PVDD short to ground		200	300	400	mA
Class K	power amplifier (Mode1 to Mode4	4)				
Iq	Quiescent current	V _{DD} =4.2V, Vin=0, no load		10	15	mA
η	Efficiency	V_{DD} =3.6V, Po=1.0W, R _L =8 Ω +33 μ H		80		%
Fosc	Modulation frequency	V _{DD} =3.0V to 5.5V	600	800	1000	kHz
Av	Gain	External input resistance=3kΩ		16.3		V/V
Vin	Recommended max input voltage	V _{DD} =3.0V to 5.5V			1	Vp
Rini	Internal input resistor	Mode1 to Mode4		16.6		kΩ
Fhin	Input high pass filter corner frequency	Cin=47nF, external input resistor=3kΩ		173		Hz
		V _{DD} =4.2V, R _L =8Ω+33μH	1.08	1.2	1.32	W
		V _{DD} =4.2V, R _L =6Ω+33μH	1.44	1.6	1.76	W
	Mode1 NCN output AGC power	V _{DD} =4.2V, R _L =4Ω+15μH	2.16	2.4	2.64	W
_		V _{DD} =4.2V, R _L =3Ω+15μH	2.16	2.4	2.64	W
Pagc		V_{DD} =4.2V, R _L =8 Ω +33 μ H	0.9	1	1.1	W
		V_{DD} =4.2V, R _L =6 Ω +33 μ H	1.17	1.3	1.43	W
	Mode2 NCN output AGC power	V_{DD} =4.2V, R _L =4 Ω +15 μ H	1.8	2	2.2	W
		V_{DD} =4.2V, R _L =3 Ω +15 μ H	2.16	2.4	2.64	W



	Parameter	Test Conditions	Test Conditions			Max	Unit
		V _{DD} =4.2V, R _L =8Ω+33μH			0.8	0.88	W
	Mada O NON autout A O O a succession	V _{DD} =4.2V, R _L =6Ω+33μH			1	1.1	W
	Mode3 NCN output AGC power	V _{DD} =4.2V, R _L =4Ω+15μH		1.44	1.6	1.76	W
		V _{DD} =4.2V, R _L =3Ω+15μH		1.8	2.0	2.2	W
Pagc		V_{DD} =4.2V, R_L =8 Ω +33 μ H		0.54	0.6	0.66	W
		V_{DD} =4.2V, R_L =6 Ω +33 μ H		0.72	0.8	0.88	W
	Mode4 NCN output AGC power	V _{DD} =4.2V, R _L =4Ω+15μH		1.08	1.2	1.32	W
		V _{DD} =4.2V, R _L =3Ω+15μH		1.44	1.6	1.76	W
2022			217Hz		-68		dB
PSRR	Power supply rejection ratio	V _{DD} =4.2V, Vp-p_sin=200mV	1kHz		-68		dB
SNR	Signal-to-noise ratio V_{DD} =4.2V, Po=1.75W, THD+N=1%, R _L =8Ω+33μH Av=8V/V			97		dB	
		V _{DD} =4.2V, f=20Hz to 20kHz, input ac grounded, A-weighting	Av=8V/V		53		μVrms
Vn	Output noise voltage		Av=12V/V		58		μVrms
		ao groundou, / t morgining	Av=16V/V		68		μVrms
TUD N	+	V_{DD} =3.6V, Po=1W, R _L =8 Ω +33 μ H, f=1kHz, Mode1			0.008		%
THD+N	Total harmonic distortion+noise	V_{DD} =3.6V, Po=1W, R _L =6 Ω +33 μ H, f=1kHz, Mode1			0.008		%
One Wire	e Pulse Control			ı		I	
T _H	SHDN high level duration time	V _{DD} =3.0V to 5.5V		0.75	2	10	μs
TL	SHDN low level duration time	V _{DD} =3.0V to 5.5V		0.75	2	10	μs
T _{LATCH}	SHDN turn on delay time	on delay time V _{DD} =3.0V to 5.5V		150		500	μs
T _{OFF}	SHDN turn off delay time	V _{DD} =3.0V to 5.5V		150		500	μs
NCN (Not	e 5)			1	ı	ı	
T _{AT}	Attack time	-13.5dB gain attenuation completed			40		ms
T_RL	Release time	13.5dB gain release completed			1.2		S
A _{MAX}	Maximum attenuation				-13.5		dB

Note 5: Attack Time refers to the duration of gain attenuation by 13.5dB. Similarly, Release Time refers to the duration of gain recovery by 13.5dB.



MEASUREMENT SETUP

AW8737A features switching digital output, as shown in Figure 6. It is crucial to connect a low pass filter after VOP/VON outputs, respectively, to filter out switch modulation frequency, then measure the differential output of filter to obtain audio analog output signal.

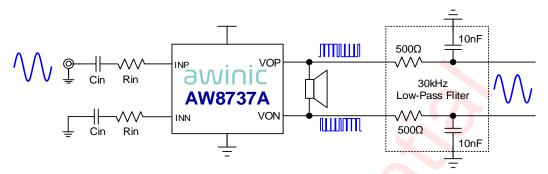


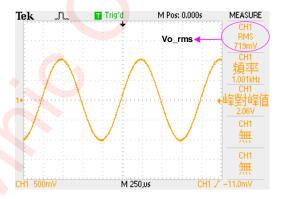
Figure 6 AW8737A Test Setup

The values of resistor and capacitor used by low pass filter are listed below:

R _{filter}	C _{filter}	Low-pass cutoff frequency
500Ω	10nF	32kHz
1kΩ	4.7nF	34kHz

Output Power Calculation

According to the above test method, the differential audio analog output signal is obtained at the output of the low pass filter. The valid value Vo_rms of the differential signal is as shown below:



The power calculation of Speaker is as follows:

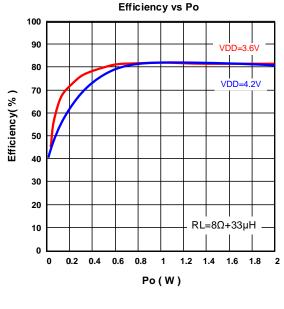
$$P_L = \frac{V_{O_RMS}^2}{R_L}$$

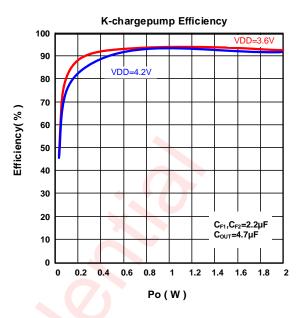
(R_L: Load Impedance of the speaker)

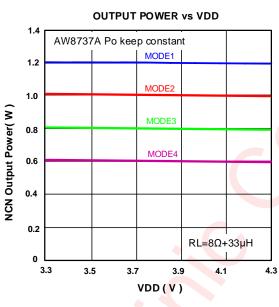
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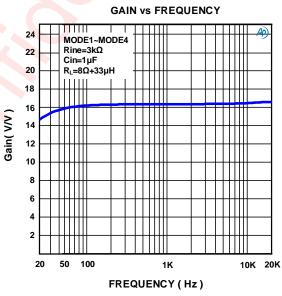


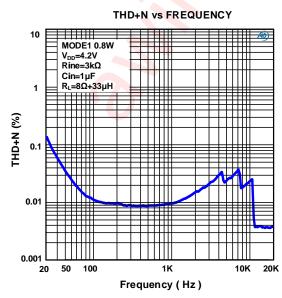
TYPICAL CHARACTERISTICS

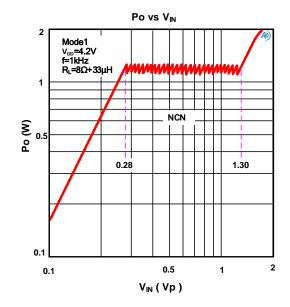




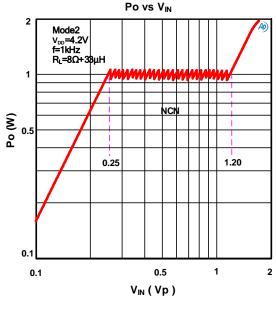


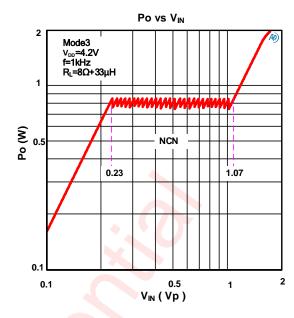


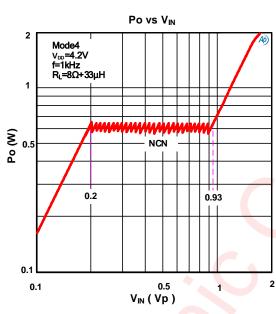


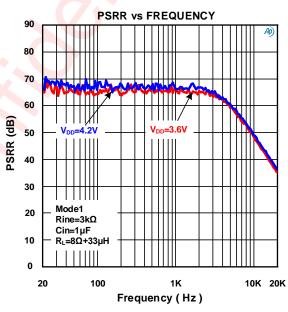


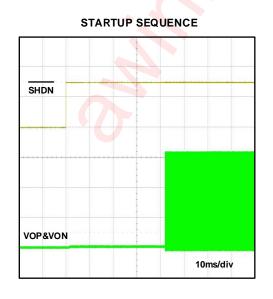


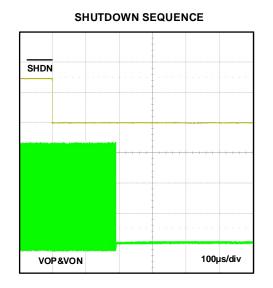




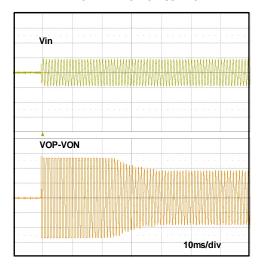




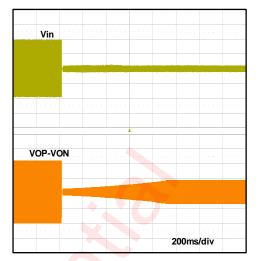




NCN ATTACK SEQUENCE



NCN RELEASE SEQUENCE





DETAILED FUNCTIONAL DESCRIPTION

AW8737A is specifically designed to enhance overall sound quality. It is an upgrading 7th-generation class K audio amplifier with high efficiency, low noise, ultra-low distortion and capability of outputting constant large volume.

With integrated AWINIC proprietary NCN output AGC audio algorithm, AW8737A can eliminate noise in playback and improve sound quality and effect. Using a novel K-Chargepump technology, its integrated charge pump efficiency can reach 93%, and power amplifier's overall efficiency can reach 80%. With high efficiency, AW8737A can greatly prolong smart phone usage time.

AW8737A noise floor is as low as to 53µV, with 97dB high signal-to-noise-ratio (SNR). The ultra-low distortion 0.008% brings high-quality musical enjoyment.

AW8737A has a setting of 4-step selectable speaker-guard output power level from 0.6W to 1.2W, suitable for different rated power speakers. Within lithium battery voltage range, it keeps output power constant, preventing voice from degrading.

THE AW8737A uses awinic proprietary TDD-Noise suppression technology and EMI suppression technology, effectively restrain TDD-Noise and EMI interference.

AW8737A has built-in over-current protection, over-temperature protection and short-circuit protection. AW8737A is available in a 1.60mm×1.60mm, 0.4mm pitch FC-16 package.

Constant Output Power

In the smart phone audio applications, the AGC function which can promote music volume and audio quality is very attractive, but as the lithium battery voltage drops, the driver capability of ordinary audio power amplifiers will reduce gradually, leading to degrading audio effect. Therefore, it is hard to provide high-quality music within the battery voltage range.

With integrated AWINIC proprietary NCN output AGC audio algorithm and within lithium battery voltage range (3.3V to 4.35V), AW8737A can keep output power constant and never decreasing during lithium battery voltage dropping down. As a result, even if the battery voltage drops, AW8737A can still provide high-quality large-volume music enjoyment.

AW8737A has 4 operating modes. They have NCN output AGC function and their output AGC power levels are 1.2W, 1W, 0.8W, 0.6W, respectively.

2nd Generation NCN Technology

In audio application, there is undesirable distortion in a clipping output signal, because of a too large input signal along with a drop of supply voltage powered by lithium battery. To prevent a speaker load from permanent damage by a clipping output signal, adoption of traditional NCN technology can adjust gain of power amplifier automatically by detecting "Crack" distortion in a output signal, and keep the output signal smooth without clipping. NCN function can effectively prevent a power amplifier overloading, protect a speaker load, and bring high quality music enjoyment at the same time. A traditional NCN function is shown in Figure 7 below.

By adopting AWINIC unique 2nd generation NCN technology, AW8737A's output signal is not limited by lithium battery voltage. When battery voltage drops, output signal keeps unchanged and free from distortion, realizing constant output power as shown in figure 8. Therefore, even if battery voltage drops, AW8737A can still provide high quality large volume music enjoyment.



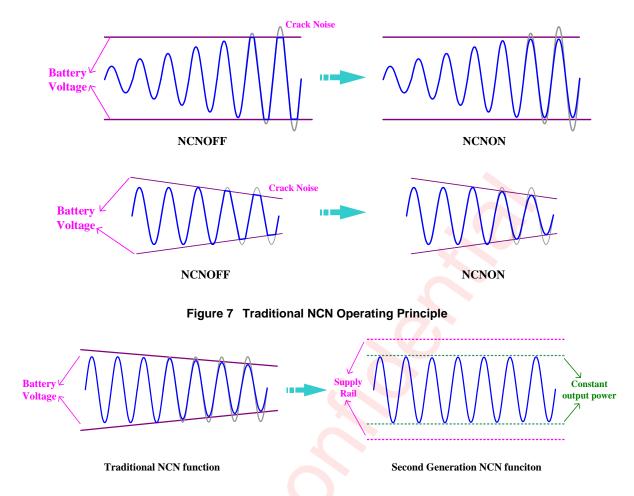


Figure 8 2nd Generation NCN Operating Principle

Attack Time

Attack time is the time which NCN output AGC takes for the gain to be attenuated by 13.5dB when audio signal exceeds the constant output power threshold level. Short attack time (fast attack) allows NCN function to react quickly and suppress harmful transients. However, it can lead to volume pumped and make process of gain reduction noticeable. While long attack time (slow attack) makes NCN function ignore fast transients and act upon longer passages instead, resulting in an increase of distortion. According to audio features in portable equipment, attack time in AW8737A is set to be 40ms, improving the music rhythm, eliminating crack distortion, and protecting the speaker at the same time.

Release time

Release time is the time which NCN output AGC takes for the gain to return to its setting value when audio signal is smaller than clipping level or constant output power threshold level. According to features of music noise in smart phone application and demands for better music quality and volume, release time of AW8737A is designed to be 1.2s, which can effectively eliminate the noise, and make sound smoother.

K-Chargepump

AW8737A adopts a new generation of charge pump technology: K-Chargepump structure. It has higher efficiency and larger driving capability. Its operating frequency is 1.06MHz. With built-in soft-start circuit, current-limit control loop and over-voltage-protection (OVP) loop, charge pump of this configuration can provide more stable and reliable power supply.



High Efficiency

The output voltage PVDD is 1.5 times of supply voltage VDD in K-Chargepump, of which the ideal efficiency can reach 100%. Actually, the K-Chargepump efficiency can be calculated as the ratio of output power to input power, that is

$$\eta = \frac{P_{OUT}}{P_{IN}} \times 100 \%$$

For example, in an ideal M-times charge pump, the input current I_{IN} is M times of the output current I_{OUT} , the efficiency formula can be written as:

$$\eta = \frac{P_{OUT}}{P_{IN}} \times 100 \% = \frac{V_{OUT} \cdot I_{OUT}}{V_{IN} \cdot M \cdot I_{OUT}} \times 100 \% = \frac{V_{OUT}}{M \cdot V_{IN}} \times 100 \%$$

Also, M is a parameter depending on the operating mode of a charge pump; VOUT is the output voltage of a charge pump; VIN is the input voltage (generally is also the power supply voltage) of a charge pump; I_{OUT} is also the load current. For K-Chargepump structure, the output voltage is 1.5 times of the input voltage. Due to the switch loss and quiescent current loss inside the charge pump, the actual efficiency can still be up to 93%. As a result, the power booster technology of K-Chargepump can greatly improve the power efficiency.

K-Chargepump Structure

As shown in Figure 9 is a K-Chargepump fundamental functional diagram: K-Chargepump integrated in AW8737A has seven switches, of which the output voltage PVDD is boosted to 1.5 times as input voltage VDD through seven switches operating timing.

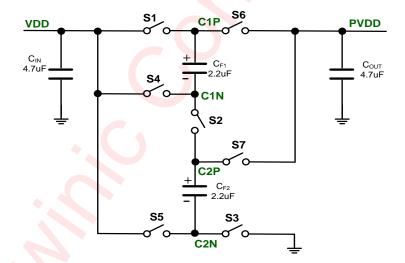


Figure 9 K-Chargepump Functional Diagram

The operation of the charge pump has two phases. In Φ_1 , as shown in Figure 10, when switches S1, S2 and S3 are closed, VDD charges to the flying capacitor C_{F1} and C_{F2} .



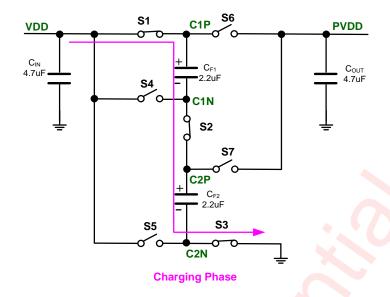


Figure 10 Φ₁: Charge Flying Capacitors C_{F1} and C_{F2}

In Φ_2 , as shown in Figure 11, switches S1, S2 and S3 are opened, and switches S4, S5, S6 and S7 are closed. Because the voltage across the capacitor can't change instantaneously, so either the voltage on flying capacitors C_{F1} or C_{F2} , is added to the VDD, realizing a PVDD boosted to a higher voltage.

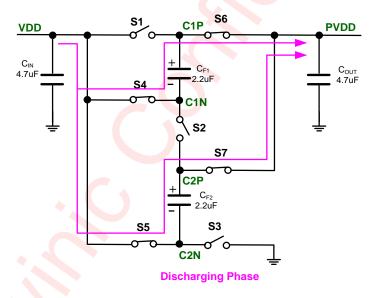


Figure 11 Φ₂: Flying Capacitor Charges Transfer to the Output Capacitor C_{OUT}

Soft Start

K-chargepump has integrated soft start function in order to limit inrush current from power supply during startup. The current from power supply can be limited to 300mA, and the start-up time is about 1.2ms.

Peak Current Control

K-chargepump has integrated a peak current control circuit. In normal operation, when a heavy load or a situation that makes the charge pump extracts very large current from power supply, the peak current control circuit can limit the maximum output load current, which is typically 2A.

Over-Voltage Protection (OVP)

K-Chargepump keeps the output voltage PVDD a multiple of the input voltage VDD. It provides a high voltage power rail for internal power amplifier circuits, allowing the amplifiers provide greater output dynamic range in



the lithium battery voltage range, realizing much larger volume, higher audio quality. K-Chargepump has integrated a over-voltage protection circuit. When the input voltage VDD is greater than 4V, the output voltage PVDD is no longer a multiple of VDD, but a controlled voltage by over-voltage protection (OVP) circuit and kept in 6.05V. The hysteresis voltage of OVP is about 50mV.

One-Wire Pulse Control: Principle

One-wire pulse control technology only needs a single GPIO port to turn on the chip and select a variety of functions. It is very popular in an environment lack of GPIO ports, such as portable systems.

Considering the problems of signal integrity or RF interference, there is narrow glitch in signal line when the PCB routine is too long. AWINIC one-wire pulse control technology integrated a deglitch circuit along with the internal control pin. The deglitch-module can completely eliminate the harmful glitch interference, as shown in Figure 12.

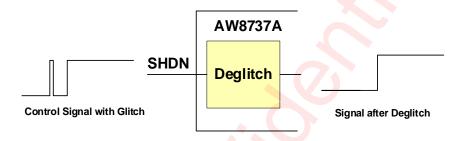


Figure 12 AWINIC Deglitch Working Principle

The traditional one-wire pulse control technology keeps working after the slave chip is powered up. Therefore, when the master chip (such as Baseband in a smart phone) sends other control signal through the same control port, the slave chip will probably enter into a wrong state. AW8737A uses one-wire pulse technology with a latch circuit, by which the right working state will be stored after the master chip sending order and AW8737A will no longer receive successive signals (except shutting down the chip firstly), as shown in Figure 13.

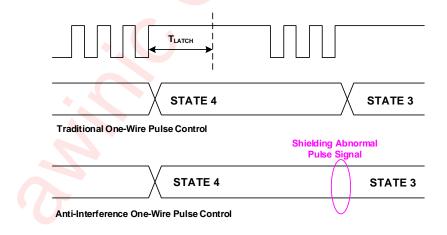


Figure 13 Anti-Interference One-Wire Pulse Control Functional Diagram

One-Wire Pulse Control: Working Mode

Each mode of AW8737A can be set by the on-wire pulse control circuit, which can detect the number of pulses sent by master chip through SHDN pin. When SHDN pulls to high level from shutdown state (low level), i.e. only a rising edge, AW8737A will enter into Mode1, and the constant output power level of NCN output AGC is 1.2W (with 8Ω speaker load). When SHDN shows a high-to-low-to-high logic signal, i.e. a rising edge after a pulse, or two rising edges, AW8737A will enter into Mode2, and the level is 1.0W. Similarly, N rising edges



means Mode"N", as shown in Figure 14. After all, AW8737A has four operating modes, more than four rising edges is forbidden.

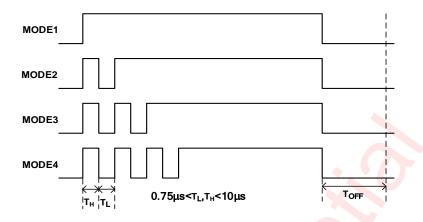


Figure 14 Working Mode Setting through One-Wire Pulse Control

To change the working mode of AW8737A, one needs to keep SHDN low longer than T_{OFF} firstly (1ms is recommended), to shut down the chip. Then, send pulses to bring the chip into a right mode, as shown in Figure 15.



Figure 15 Mode Switch through One-Wire Pulse Control

RNS (RF Noise Suppression)

GSM transmission adopts TDMA (Time Division Multiple Access) Technology which results in frame burst at frequency of 217Hz, also called TDD (Time Division Duplexing), leading to a strong RF interference (RF Noise) and the 217Hz energy along with its harmonics (TDD Noise) can be easily interacted with audio power amplifiers.

In applications, optimization of both layout and selection of peripheral components may decrease the AW8737A's susceptibility to RF noise and prevent TDD Noise from being demodulated into audible noise. Minimization of length of routings prevents them from functioning as antennas and coupling RF noise into an AW8737A. Further RF immunity can also be realized by using capacitors of which feature of frequency response is like a notch filter. Depending on manufacturers, self-resonance frequency of 10pF to 20pF capacitors typically located at RF band. Such capacitors placed in front of input pins of AW8737A can effectively suppress RF noise. Also, such capacitors must have a low-impedance, low-inductance path to the ground plane.

Even if part of RF energy is injected into AW8737A by traces connected to the chip, regardless of efforts of TDD Noise Reduction. AW8737A features a unique RNS technology, which effectively reduces RF energy and attenuates RF TDD-noise to an acceptable audible level for customers.



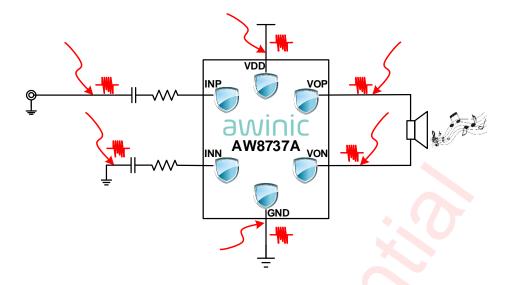


Figure 16 AW8737A Rejection of RF Noise

Filter-Free Pulse Width Modulation (Filter-Free PWM)

AW8737A features a filter-free PWM architecture which removes a LC filter behind the output stage of a traditional Class D power amplifier, resulting in improvement of overall efficiency, decrease of PCB area and reduction of system cost.

Enhanced Emission Elimination (EEE)

AW8737A features a unique Enhanced Emission Elimination (EEE) technology, which adjusts the speed of waveform transition of PWM output signal, and effectively reduces EMI over FM/AM bandwidth.

Pop-Click Suppression

AW8737A integrates a unique timing-control circuit, which fundamentally suppresses pop-click noise, and eliminates audible crack at shut-down, wake-up, and power-up/down.

Protection

When a short-circuit occurs among output pins (VOP, VON) and power pins (VDD, GND, PVDD) of AW8737A, an over-current protection (OCP) circuit will be trigged and shut down the chip immediately, preventing the device from being damaged. When abnormal condition is removed, AW8737A can restart automatically without wake-up.

When junction temperature in AW8737A is too high, an over-temperature protection (OTP) circuit will be triggered and shut down the chip immediately. The circuit will turn the device on once the temperature decrease into a safe scope.



APPLICATION INFORMATION

Gain Setting -- Selection of External Input Resistor (Rine)

AW8737A is a differential-input audio power amplifier. It integrates two internal input resistors (R_{ini}), which are both 16.6k Ω . Take external input resistors R_{ine} =3k Ω for instance, overall gain (A_V) can be set as below:

Class K Speaker Mode (Mode1~4):
$$A_V = \frac{319.5k\Omega}{R_{ine} + R_{ini}} = \frac{319.5k\Omega}{3k\Omega + 16.6k\Omega} = 16.3V/V$$

Input High-Pass Cutoff Frequency Setting -- Selection of Input Capacitor (Cin)

Input capacitors in front of external input resistors can block DC component of input audio signals. An input capacitor (C_{in}) along with input resistors ($R_{ine}+R_{ini}$) forms an input high-pass filter with a corner frequency (f_H) calculated as below:

$$f_H(-3dB) = \frac{1}{2\pi(R_{ine} + R_{ini})C_{in}}$$

A higher f_H results in a better suppression of 217Hz GSM input noise. A better matching of input capacitors improves capability of blocking of common-mode interference of input stage in AW8737A and also helps to reduce pop-click noise.

Take typical application in Figure 1 for instance:

$$f_H(-3dB) = \frac{1}{2\pi (R_{ine} + R_{ini})C_{in}} = \frac{1}{2\pi \cdot 19.6k\Omega \cdot 47 \, nF} = 173 \, Hz$$

Input Low-Pass Cutoff Frequency Setting – Selection of Differential Input Capacitor (C_d)

A differential input capacitor behind external input resistors can block high-frequency component of input audio signals, such as screechy part in a song. A differential input capacitor (C_d) along with input resistors ($R_{ine}+R_{ini}$) forms an input low-pass filter with a corner frequency (f_L) calculated as below:

$$f_L(-3dB) = \frac{1}{4\pi (R_{ine} // R_{ini})C_d}$$

Take typical application in Figure 1 with C_d=220pF and R_{ine}=3kΩ for instance:

$$f_L(-3dB) = \frac{1}{4\pi \cdot (3k\Omega // 16.6k\Omega) \cdot 220 \ pF} = 142.5kHz$$

Selection of Power Supply Decoupling Capacitor (Cs)

AW8737A is a high-performance audio power amplifier. It is essential to place a ceramic capacitor (Cs) with low equivalent-series-resistance (ESR) (typical 0.1uF) for power supply decoupling. Optimized selection and placement of decoupling capacitors protect AW8737A from interference injection from power supply, such as high-frequency transients, spikes, or digital noise. Specifically, a layout of decoupling capacitor closer to

AW8737A Nov 2021 V1.0

AW8737A is preferred, since fewer parasitic resistance or inductance between power pin and the capacitor, less decoupling efficiency loss. In addition to a 0.1µF ceramic capacitor, another 10µF capacitor as a charge reservoir is required, providing transient power energy for AW8737A and preventing remarkable drop of the power supply voltage.

Selection of Charge Pump Flying Capacitor (C_F)

Value of charge pump flying capacitors (C_F) affects load regulation and output impedance of the charge pump. Small capacitance may degrade driving capability of AW8737A. A 2.2µF/6.3V ceramic capacitor is usually recommended.

Selection of Charge Pump Output Capacitor (Cout)

Capacitance and ESR of charge pump output capacitors (C_{OUT}) directly affect ripple magnitude of charge pump output voltage (PVDD). Increasing C_{OUT} Capacitance reduces variations of PVDD and decreasing C_{OUT} ESR also reduces both ripple and output resistance. A 4.7µF/10V ceramic capacitor is usually recommended.

Usage of Ferrite Bead and Filter Capacitor

Without ferrite beads and filter capacitors, AW8737A can still pass the specifications of FCC and CE. If there is any EMI sensitive device near AW8737A and/or there are long traces routing from the amplifier to a speaker, use ferrite beads and filter capacitors and place beads and capacitors as close as possible to output pins (VOP&VON), as Figure 17 below.

In Class K Speaker Mode, outputs of AW8737A are square-wave PWM signals, which charge and discharge filter capacitors in each period, and result in additional static power consumption. Bigger filter capacitance, larger current consumption. Therefore, 0.1nF ceramic capacitor is usually recommended for low power application.

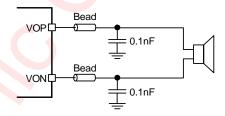


Figure 17 Ferrite Beads and Filter Capacitors



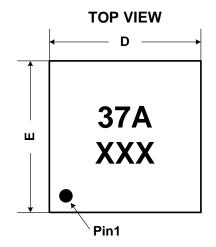
PCB AND DEVICE LAYOUT CONSIDERATION

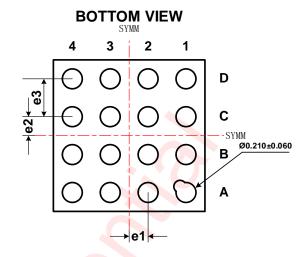
In order to exploit best performance of AW8737A, PCB layout must be carefully considered. Design consideration should be followed as below:

- Isolated, short and wide power lines for both VDD pin and GND pin are required for better drivingcapability of AW8737A. The copper width is recommended to be larger than 0.75mm (30mil). Power supply decoupling capacitors should be placed as close as possible to power supply pins.
- 2. Flying capacitors C_{F1}, C_{F2} should be placed as close as possible to C1N, C1P pins and C2N, C2P pins. Likewise, capacitor C_{OUT} should be close to PVDD pin. The trace from C_{OUT} to both PVDD pin and GND pin should be short and wide.
- 3. Input capacitors and resistors should be close to INN and INP pins. Differential and ground-shielding input routing is required to suppress noise coupling.
- 4. Ferrite beads and filter capacitors should be close to VON and VOP pins. The trace from output pins to speaker should be short and wide. The copper width is recommended to be larger than 0.5mm (20mil).

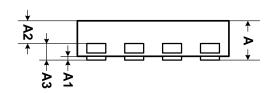


PACKAGE INFORMATION FOR AW8737AFCR



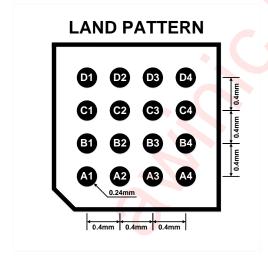






NOM	Tolerance
0.55	±0.05
0.02	-0.02/+0.03
0.4	NA
0.152	NA
1.6	±0.1
1.6	±0.1
0.200	NA
0.200	NA
0.400	NA
	0.55 0.02 0.4 0.152 1.6 1.6 0.200

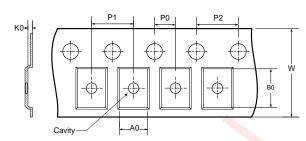
Unit: mm



TAPE AND REEL INFORMATION FOR AW8737AFCR

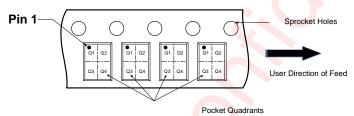
REEL DIMENSIONS 0 D1

TAPE DIMENSIONS



- A0: Dimension designed to accommodate the component width
- B0: Dimension designed to accommodate the component length
- K0: Dimension designed to accommodate the component thickness
- W: Overall width of the carrier tape
- P0: Pitch between successive cavity centers and sprocket hole
- P1: Pitch between successive cavity centers
- P2: Pitch between sprocket hole
- D1: Reel Diameter
- D0: Reel Width

QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



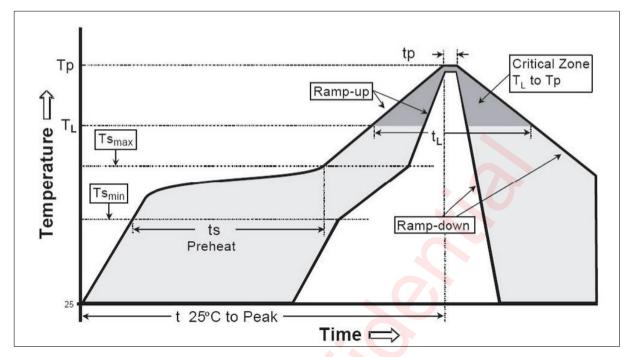
DIMENSIONS AND PIN1 ORIENTATION

	-	_							
D1	D0	A0	В0	K0	P0	P1	P2	W	Pin1 Quadrant
(mm)	(mm)	(mm)	(mm)	(mm)	(mm)	(mm)	(mm)	(mm)	Fiiii Quaurani
178.0±1.0	8.4+2.0/-0.0	1.81±0.05	1.81±0.05	0.76±0.05	2.00±0.05	4.00±0.10	4.00±0.10	8.00+0.30/-0.10	Q1

- Notes: 1. ALL DIMS IN MM
- 2. MATERIAL: BLACK CONDICTIVE PC
 3. 10 pocket hole pitch cumulative tolerance ±0.20mm
- 4. The meander of the tape is within 1mm in 250mm
 5. Surface resistance 1×10E⁴<Rs<1×10E¹¹OHMS
 6. Friction Voltage <100V



REFLOW SOLDERING CURVE



Reflow Note	Spec				
Average Ramp-up Rate (217°C to Peak)	Max. 3°C/sec				
Time of Preheat temp. (from 150°C to 200°C) 60s					
Time to be Maintained above 217°C	60sec-150sec				
Peak Temperature 250°C					
Time within 5°C of Actual Peak Temp 20sec-40sec					
Ramp-down Rate Max. 6°C/sec					
Time from 25°C to Peak Temp	Max. 8min				



VERSION INFORMATION

Version	Date	Description
V1.0	2021-12-8	AW8737AFCR datasheet V1.0 released
		. (/>



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TSDP11XX1NBGIZBX TSDP10XX1NBGIZBX NJM4580CV-TE1 TPA3223DDVR LV4910T-MPB-E NCP2890AFCT2 NCV2211DR2G
SCY99091FCT2G COS6112 LM4890SS LM4871 NS4890C AW8010BFCR COS4812 MC34018M/TR LM4890MM/TR ME5301ASPG
LM386M-1 TAS5720MRSMR BL6281GMM BL6281GSO-R BL6281GSO CS3818EO CS3817BEO CS3815EO LM4861BM/TR
LM386BN-1 TDA2822N MC34118M/TR